FAIRCHILD

SEMICONDUCTOR

FQD11P06 / FQU11P06 **60V P-Channel MOSFET**

General Description

These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- -9.4A, -60V, R_{DS(on)} = 0.185Ω @V_{GS} = -10 V
 Low gate charge (typical 13 nC)
- Low Crss (typical 45 pF) •
- Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- S D Go I-PAK D-PAK FQD Series FQU Series GDS

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQD11P06 / FQU11P06	Units
V _{DSS}	Drain-Source Voltage		-60	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		-9.4	А
	- Continuous (T _C = 100	-5.95	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	-37.6	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		160	mJ
I _{AR}	Avalanche Current	(Note 1)	-9.4	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-7.0	V/ns
PD	Power Dissipation (T _A = 25°C) *		2.5	W
	Power Dissipation ($T_C = 25^{\circ}C$)		38	W
	- Derate above 25°C	0.3	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

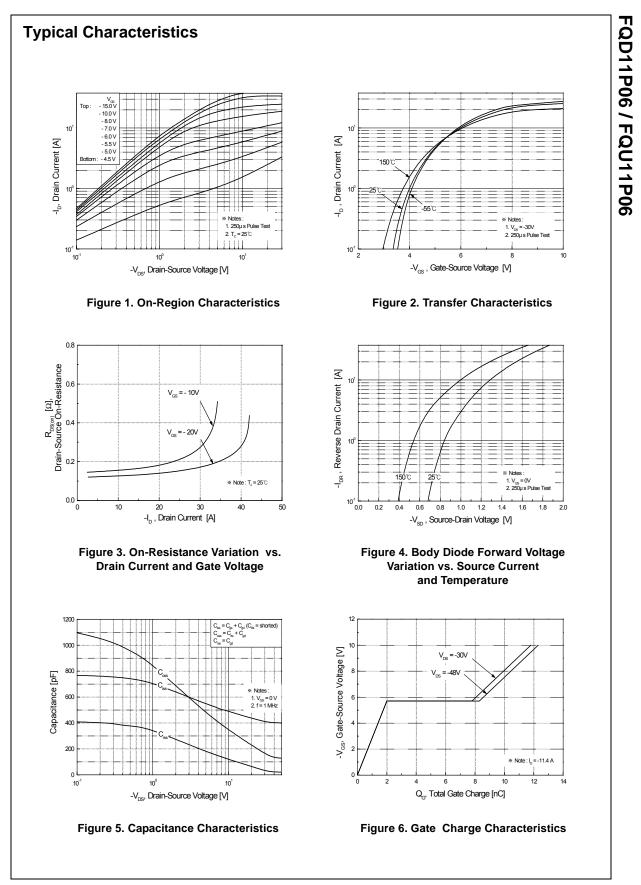
Thermal Characteristics

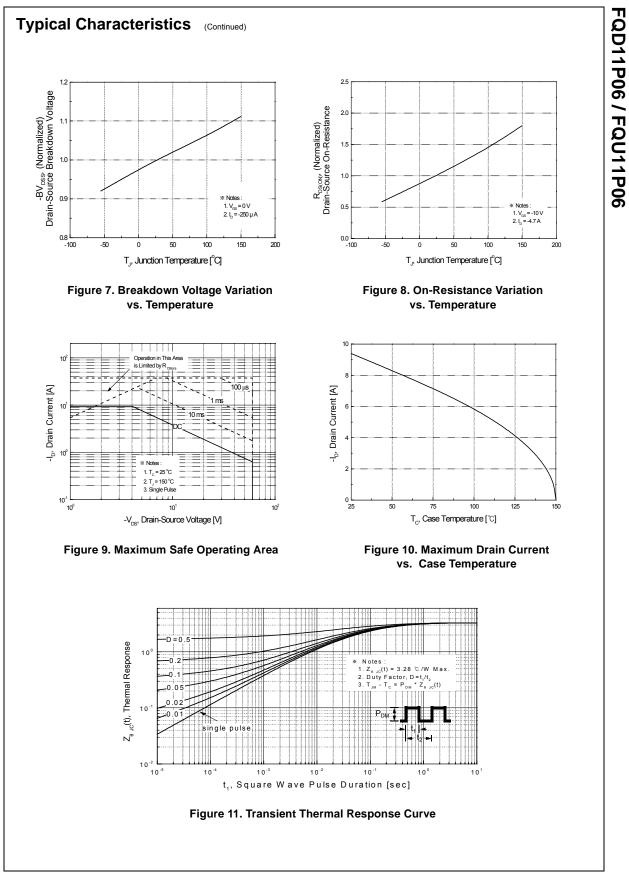
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		3.28	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient		110	°C/W

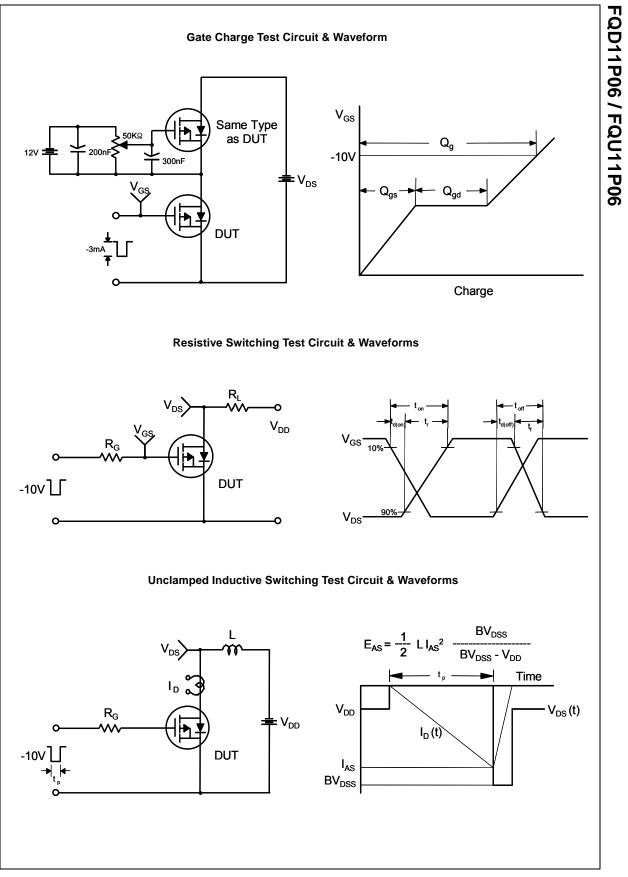
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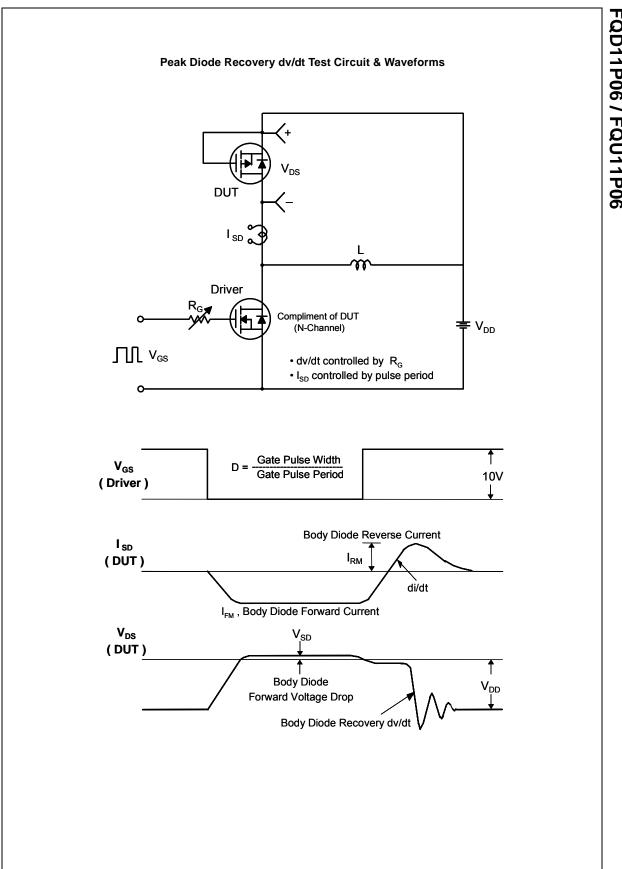
FET®

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-0.07		V/°C
DSS		V _{DS} = -60 V, V _{GS} = 0 V			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 125°C			-10	μA
GSSF	Gate-Body Leakage Current, Forward	V_{GS} = -25 V, V_{DS} = 0 V			-100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = 25 V, V_{DS} = 0 V$			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -4.7 A		0.15	0.185	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -30 V, I _D = -4.7 A (Note 4)		4.9		S
Dynam C _{iss}	ic Characteristics			420	550	~F
	Output Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$		420 195	550	pF
C _{oss} C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		45	250 60	pF pF
d(on)	Turn-On Delay Time	V _{DD} = -30 V, I _D = -5.7 A,		6.5 40	25 90	ns ns
r	Turn-On Rise Time	$R_G = 25 \Omega$	-	40	90	ns
1/ . (7)	Turn-Off Delay Time			15	40	ns
	Turn-Off Fall Time	(Note 4, 5)		45	100	ns
f				13	17	nC
f Qg	Total Gate Charge	V _{DS} = -48 V, I _D = -11.4 A,				<u> </u>
f Qg	Total Gate Charge Gate-Source Charge	V _{DS} = -48 V, I _D = -11.4 A, V _{GS} = -10 V		2.0		nC
f Q _g Q _{gs}	-			2.0 6.3		nC nC
f Ձց Ձցց Ձցց	Gate-Source Charge	V _{GS} = -10 V (Note 4, 5)				
f ຊ _g ຊ _{gs} ຊ _{gd} Drain-S	Gate-Source Charge Gate-Drain Charge	V _{GS} = -10 V (Note 4, 5)				
^{id} (off) Դց Չց Չցց Ձցց Drain-S	Gate-Source Charge Gate-Drain Charge ource Diode Characteristics a	V _{GS} = -10 V (Note 4, 5) nd Maximum Ratings ode Forward Current Forward Current		6.3		nC
ີ່ ຊ _g ຊ _{gs} ຊ _{gd} Drain-S	Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Dio	V _{GS} = -10 V (Note 4, 5) nd Maximum Ratings ode Forward Current		6.3		nC A
f Q _g Q _{gs} Q _{gd} Drain-S S S M / _{SD} rr	Gate-Source Charge Gate-Drain Charge Source Diode Characteristics au Maximum Continuous Drain-Source Dio Maximum Pulsed Drain-Source Diode F	$V_{GS} = -10 V$ (Note 4, 5)		6.3 	 -9.4 -37.6	nC A A
f Qg Qgs Drain-S S SM /SD r	Gate-Source Charge Gate-Drain Charge Cource Diode Characteristics an Maximum Continuous Drain-Source Diode Maximum Pulsed Drain-Source Diode F Drain-Source Diode Forward Voltage Reverse Recovery Time	$V_{GS} = -10 V$ (Note 4, 5)		6.3 83	 -9.4 -37.6 -4.0 	nC A A V ns
f Q _g Q _{gs} Q _{gd} Drain-S S S S M V _{SD} V _{SD} Q _{rr} Q _{rr} Repetitive R	Gate-Source Charge Gate-Drain Charge Cource Diode Characteristics an Maximum Continuous Drain-Source Diode Maximum Pulsed Drain-Source Diode F Drain-Source Diode Forward Voltage	$V_{GS} = -10 V$ (Note 4, 5) (Note 4)		6.3 	 -9.4 -37.6 -4.0	nC A A V

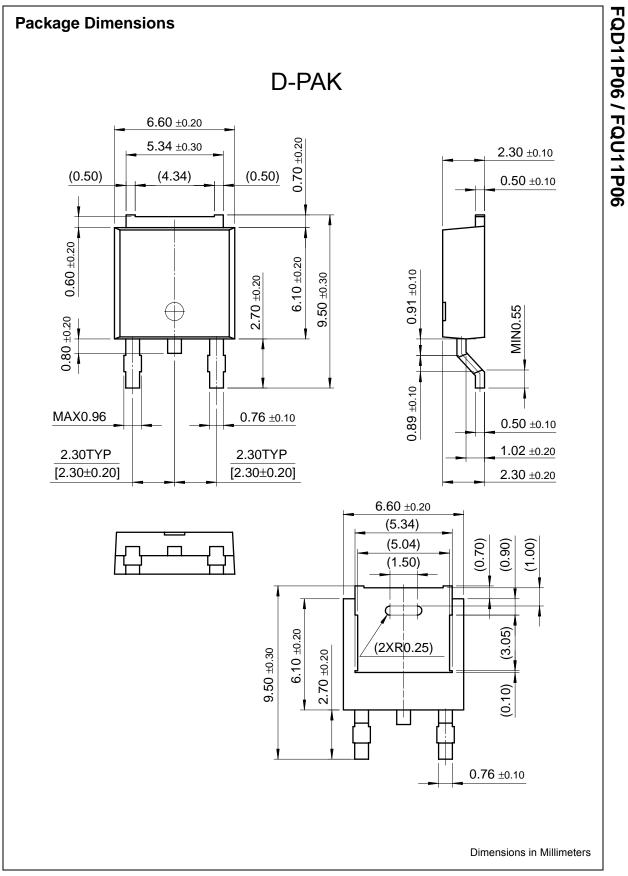


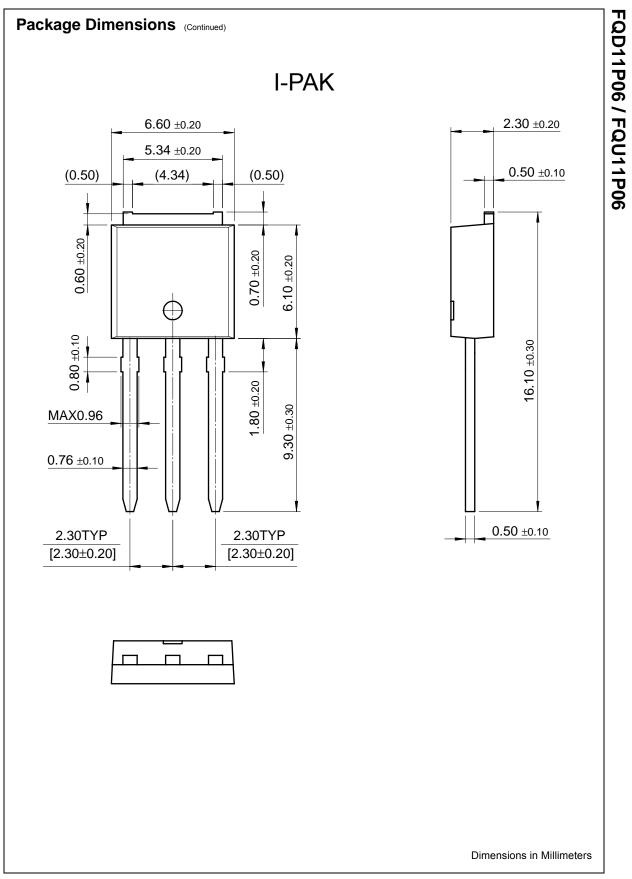






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Definition of Terms

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FQD11P06 60V P-Channel QFET

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General description

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Product status/pricing/packaging



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Product	Product status	Pb-free Status	Pricing*	Package type	Leads	Packing method	Package Marking Convention**
FQD11P06TF	Full Production	Full Production	\$0.65	<u>TO-252(DPAK)</u>	2	TAPE REEL	Line 1: \$Y (Fairchild logo) & Z (Asm. Plant Code) & 4 (4-Digit Date Code) Line 2: FQD Line 3: 11P06
FQD11P06TM	Full Production	Full Production	\$0.65	<u>TO-252(DPAK)</u>	2	TAPE REEL	Line 1: \$Y (Fairchild logo) & Z (Asm. Plant Code) & 4 (4-Digit Date Code) Line 2: FQD Line 3: 11P06
FQD11P06TM_SB82077	Full Production	Full Production	N/A	<u>TO-252(DPAK)</u>	2	TAPE REEL	Line 1: \$Y (Fairchild logo) & Z (Asm. Plant Code) & 4 (4-Digit Date Code) Line 2: FQD Line 3: 11P06

* Fairchild 1,000 piece Budgetary Pricing ** A sample button will appear if the part is available through Fairchild's on-line samples program. If there is no sample button, please contact a <u>Fairchild distributor</u> to obtain samples

Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product FQD11P06 is available. <u>Click here for more information</u>.

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Qualification Support

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Product
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